

FEATURES

- InGaP HBT Technology
- 2.5% EVM @ +28 dBm (OFDMA)
- 31 dB Gain
- Integrated Step Attenuator
- Integrated Output Power Detector
- High Efficiency
- Low Transistor Junction Temperature
- Matched for a 50 Ω System
- Low Profile Miniature Surface Mount Package; RoHS Compliant

APPLICATIONS

- WiMAX and LTE Air Interfaces
- Picocell, Femtocell, Home Nodes
- Customer Premises Equipment (CPE)
- Data Cards and Terminals



PRODUCT DESCRIPTION

The AWB7221 is a fully matched, Multi-Chip-Module (MCM) designed for picocell, femtocell, and customer premises equipment (CPE) applications. Its high linearity and efficiency meet the extremely demanding needs of small cell infrastructure architectures. Designed for WiMAX and LTE air interfaces operating in the 2.30 GHz to 2.70 GHz band, the AWB7221 delivers up to +28 dBm of WiMAX power with exceptionally low EVM. It operates from a convenient

+4.2 V supply and provides more than 30 dB of gain. The device is manufactured using an advanced InGaP HBT MMIC technology offering state-of-the-art reliability, temperature stability, and ruggedness. The self-contained 7 mm x 7 mm x 1.3 mm surface mount package incorporates RF matching networks optimized for output power, efficiency, and linearity in a 50 Ω system.

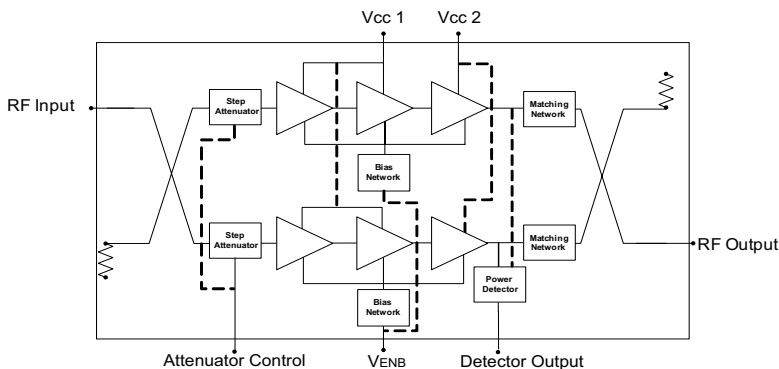


Figure 1: Block Diagram

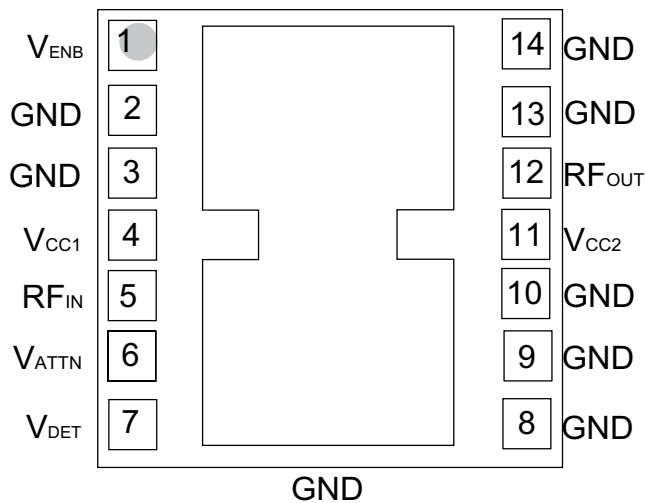


Figure 2: Pinout (X-ray Top View)

Table 1: Pin Description

PIN	NAME	DESCRIPTION
1	V_{ENB}	Enable Voltage
2	GND	Ground
3	GND	Ground
4	V_{CC1}	Supply Voltage
5	RF_{IN}	RF Input
6	V_{ATTN}	Attenuator Control
7	V_{DET}	Detector Output
8	GND	Ground
9	GND	Ground
10	GND	Ground
11	V_{CC2}	Supply Voltage
12	RF_{OUT}	RF Output
13	GND	Ground
14	GND	Ground

ELECTRICAL CHARACTERISTICS

Table 2: Absolute Minimum and Maximum Ratings

PARAMETER	MIN	MAX	UNIT
Supply Voltage (V_{CC})	0	+5	V
Enable Voltage (V_{ENB})	0	+3.2	V
Attenuator Control Voltage (V_{ATTN})	-	+3.7	V
RF Input Power (P_{IN})	-	+3.0	dBm
Junction Temperature (T_j)	-	+150	°C
Storage Temperature (T_{STG})	-40	+150	°C

Stresses in excess of the absolute ratings may cause permanent damage. Functional operation is not implied under these conditions. Exposure to absolute ratings for extended periods of time may adversely affect reliability.

Table 3: Operating Ranges

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Operating Frequency (f)	2300	-	2700	MHz	
Supply Voltage (V_{CC})	+3.3	+4.2	+4.5	V	
Enable Voltage (V_{ENB})	+2.80 0	+2.85 -	+3.1 +0.5	V	PA "on" PA "shut down"
Attenuator Control Voltage (V_{ATTN}) Logic High Logic Low	+2.3 0	- -	+3.7 +0.7	V V	Attenuator Enabled Attenuator Disabled
RF Output Power (P_{OUT})	-	+28	-	dBm	
Case Temperature (T_c)	-40	-	+85	°C	

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

Table 4: Electrical Specifications - 16 QAM P_{USC} Zone
 (T_C = +25 °C, V_{CC} = +4.2 V, V_{ENB} = +2.85 V, 50 Ω system)

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Gain ⁽²⁾	-	31	-	dB	
Attenuation	-	23	-	dB	V _{ATTN} = 2.5 V
Spectrum Mask ^{(1) (2)} @ offset A @ offset B @ offset C @ offset D @ offset E @ offset F	- - - - - -	- - - - - -	-13 -13 -19 -25 -25 -25	dBm	10 MHz Channel Bandwidth WiMAX Forum Band Class 3A MMRT
Power-Added Efficiency ^{(1) (2)}	-	17.5	-	%	
Collector Current (I _{CC}) ^{(1) (2)}	-	850	-	mA	
EVM ⁽²⁾	-	2.5	3.5	%	
Thermal Resistance (R _{JC}) ⁽³⁾	-	13	-	°C/W	Junction to Case
Power Detector Output @ 28 dBm @ 18 dBm	- -	1.30 1.0	- -	V	RL (Load Resistor) = 100 kΩ
Quiescent Current (I _{cq})	-	200	-	mA	
V _{ENB} Current	-	7	10	mA	pin 1; V _{ENB} = +2.85 V
V _{ATTN} Current	-	160	-	μA	pin 6; V _{ATTN} = +2.5 V
Leakage Current	-	50	-	μA	V _{CC} = +4.5 V, V _{ENB} = 0 V
Harmonics ⁽²⁾ 2fo, 4fo 3fo	- - -	-60 -55	-45 -45	dBc	
Input Return Loss	-	-15	-	dB	
Spurious Output Level ⁽²⁾ (all spurious outputs)	-	-	-60	dBc	In-band load VSWR < 5:1 Out-of-band load VSWR < 10:1 Applies over all voltage and temperature operating ranges
Load mismatch stress with no permanent degradation or failure	8:1	-	-	VSWR	V _{CC} = +4.5 V, P _{IN} = 0 dBm Applies over full operating temperature range

Notes:

(1) Spectrum Mask and Efficiency measured at 2500 MHz.

(2) P_{OUT} = +28 dBm.(3) Use only V_{CC2} (pin 11) current when calculating device junction temperature.

APPLICATION INFORMATION

To ensure proper performance, refer to all related Application Notes on the ANADIGICS web site: <http://www.anadigics.com>

Shutdown Mode

The power amplifier may be placed in a shutdown mode by applying logic low levels (see Operating Ranges table) to the V_{ENB} voltage.

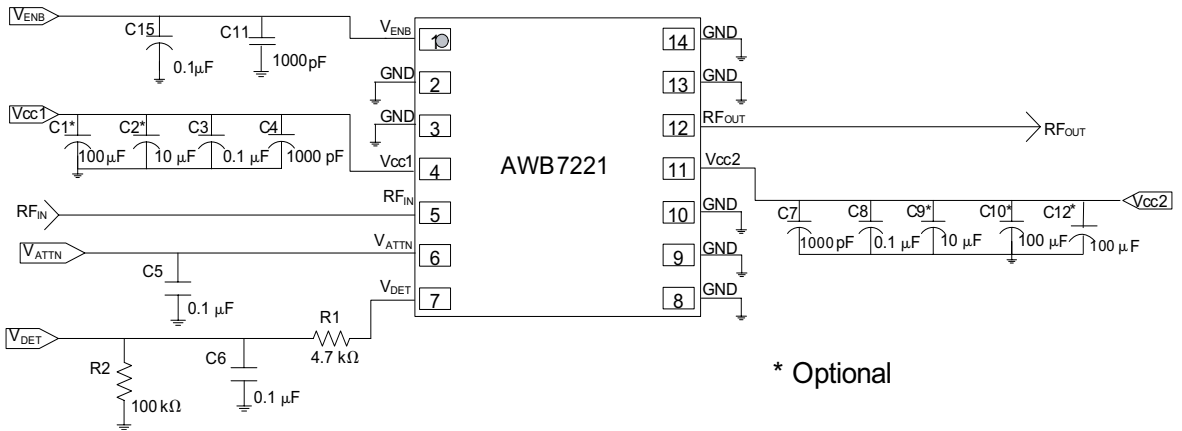
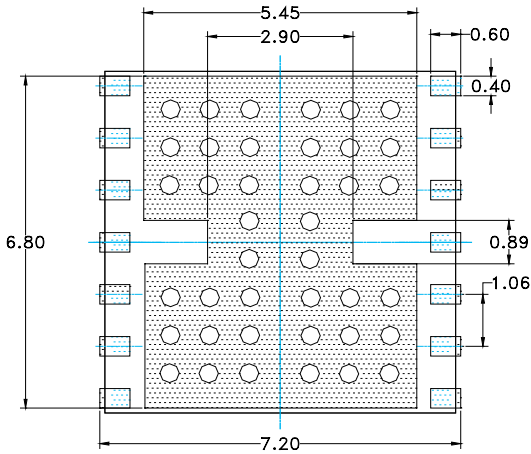


Figure 3: Application Circuit Schematic

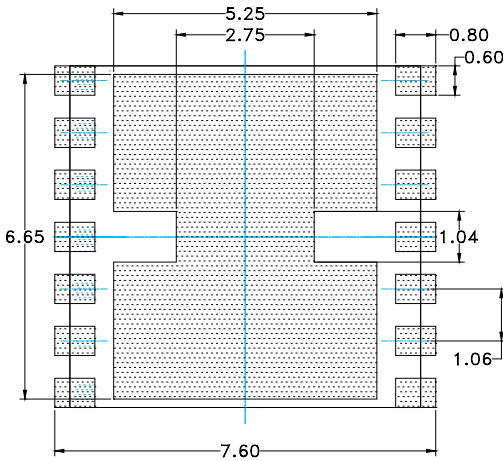


PCB METAL
TOP (X-RAY) VIEW

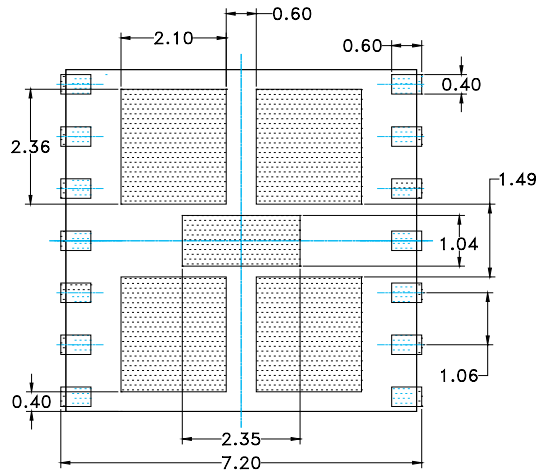
ONLY PACKAGE I/O's AND
GROUND REQUIREMENTS
SHOWN.

NOTES:

- (1) UNLESS SPECIFIED DIMENSIONS ARE SYMMETRICAL ABOUT CENTER LINES SHOWN.
- (2) DIMENSIONS IN MILLIMETERS.
- (3) VIAS SHOWN IN PCB METAL VIEW ARE FOR REFERENCE ONLY. NUMBER & SIZE OF THERMAL VIAS REQUIRED DEPENDENT ON HEAT DISSIPATION REQUIREMENT AND THE PCB PROCESS CAPABILITY.



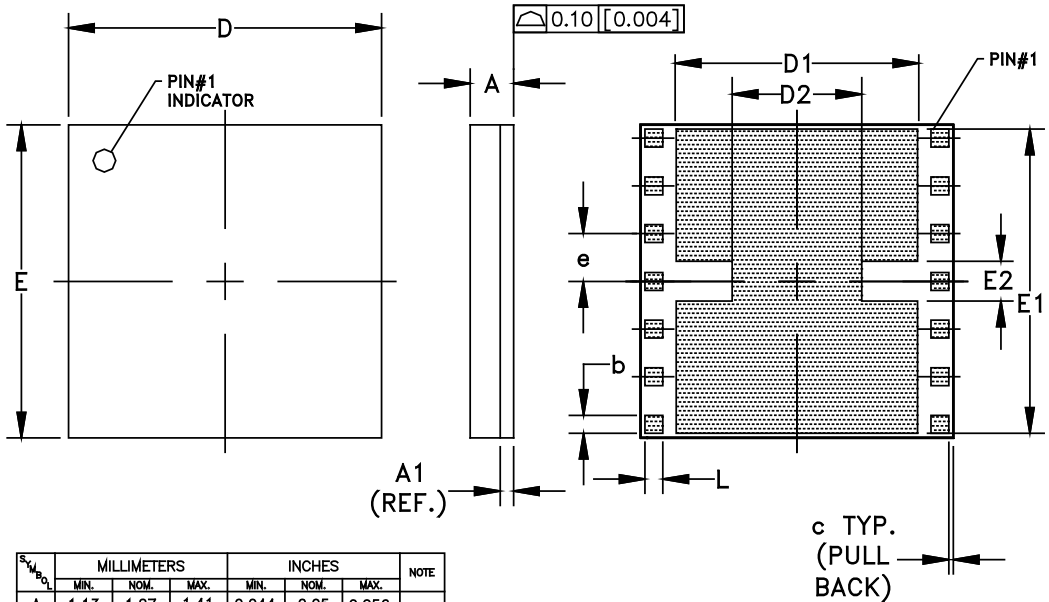
PCB SOLDER MASK
TOP (X-RAY) VIEW



STENCIL APERTURE
TOP (X-RAY) VIEW

Figure 4: PCB Footprint

PACKAGE OUTLINE



DIM.	MILLIMETERS			INCHES			NOTE
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	1.13	1.27	1.41	0.044	0.05	0.056	—
A1	0.27 (REF)			0.011 (REF)			—
b	0.387	0.400	0.413	0.0152	0.0157	0.0162	14X
c	—	0.10	—	—	0.004	—	—
D	6.88	7.00	7.12	0.270	0.275	0.280	—
D1	5.30	5.45	5.60	0.208	0.214	0.220	—
D2	2.87	2.90	2.93	0.113	0.114	0.115	—
E	6.88	7.00	7.12	0.270	0.275	0.280	—
E1	6.78	6.80	6.82	0.266	0.267	0.268	—
E2	0.86	0.89	0.92	0.034	0.035	0.036	—
e	1.07			0.0421			6X
L	0.387	0.400	0.413	0.0152	0.0157	0.0162	14X

NOTES:

1. CONTROLLING DIMENSIONS: MILLIMETERS
2. UNLESS SPECIFIED TOLERANCE=±0.076[0.003].
3. PADS (INCLUDING CENTER) SHOWN UNIFORM SIZE FOR REFERENCE ONLY. ACTUAL PAD SIZE AND LOCATION WILL VARY WITHIN MIN. AND MAX. DIMENSIONS ACCORDING TO SPECIFIC LAMINATE DESIGN.

Figure 5: M52 Package Outline - 14 Pin 7 mm x 7 mm x 1.3 mm Surface Mount Module

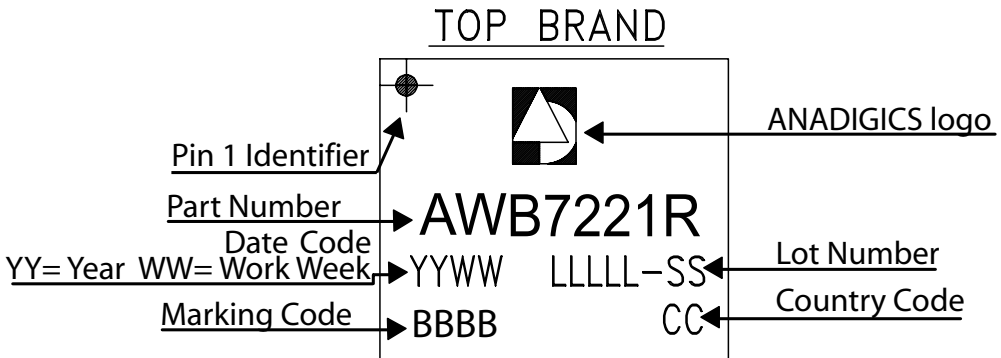


Figure 6: Branding Specification

ORDERING INFORMATION

ORDER NUMBER	TEMPERATURE RANGE	PACKAGE DESCRIPTION	COMPONENT PACKAGING
AWB7221RM52P8	-40 °C to +85 °C	RoHS-compliant 14 Pin 7 mm x 7 mm x 1.3 mm Surface Mount Module	Tape and Reel, 2500 pieces per Reel



ANADIGICS, Inc.

141 Mount Bethel Road
Warren, New Jersey 07059, U.S.A.

Tel: +1 (908) 668-5000

Fax: +1 (908) 668-5132

URL: <http://www.anadigics.com>

IMPORTANT NOTICE

ANADIGICS, Inc. reserves the right to make changes to its products or to discontinue any product at any time without notice. The product specifications contained in Advanced Product Information sheets and Preliminary Data Sheets are subject to change prior to a product's formal introduction. Information in Data Sheets have been carefully checked and are assumed to be reliable; however, ANADIGICS assumes no responsibilities for inaccuracies. ANADIGICS strongly urges customers to verify that the information they are using is current before placing orders.

WARNING

ANADIGICS products are not intended for use in life support appliances, devices or systems. Use of an ANADIGICS product in any such application without written consent is prohibited.